



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00602	REV: E1	SVN REV: Not In VersionControl
PLOT NAME = Top Assembly Drawing	GENERATED : 6/5/2015	2:54:41 PM	TEXAS INSTRUMENTS



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ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00602	REV: E1	SVN REV: Not In VersionControl
PLOT NAME = Bottom Assembly Drawing	GENERATED : 6/5/2015 2:54:42 PM	TEXAS INSTRUMENTS	

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